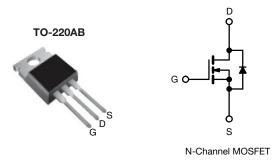
SiHP11N80E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	850			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.38		
Q _g max. (nC)	88			
Q _{gs} (nC)	9			
Q _{gd} (nC)	16			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lood (Ph) free and halogen free	SiHP11N80E-BE3 a
Lead (Pb)-free and halogen-free	SiHP11N80E-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain surrant $(T_{\rm c} = 150 ^{\circ}{\rm C})$	V _{GS} at 10 V	T _C = 25 °C	- I _D	12	
Continuous drain current (T _J = 150 °C)	VGS at 10 V	T _C = 100 °C		8	А
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.4	W/°C
Single pulse avalanche energy ^b			E _{AS}	226	mJ
Maximum power dissipation			PD	179	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dV/dt	70		
Reverse diode dV/dt ^d			4.3	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

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COMPLIANT

HALOGEN

FREE

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	00.004	
Maximum junction-to-case (drain)	R _{thJC}	-	0.7	°C/W	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•		•		•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	1.1	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		2	-	4	V
		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μA
Zana and a solitana durin assument		V _{DS} = 800 V, V _{GS} = 0 V		-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5.5 A	-	0.38	0.44	Ω
Forward transconductance	9 _{fs}	V _{DS} :	= 30 V, I _D = 5.5 A	-	4.5	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V_{,}$	-	1670	-	
Output capacitance	C _{oss}		$V_{\rm GS} = 100 \text{ V},$ $V_{\rm DS} = 100 \text{ V},$		68	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	9	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	43	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0$	V to 480 V, V_{GS} = 0 V	-	212	-	
Total gate charge	Qg			-	44	88	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	9	-	nC
Gate-drain charge	Q _{gd}			-	16	-	
Turn-on delay time	t _{d(on)}		·	-	18	36	
Rise time	t _r	V _{DD} =	= 480 V, I _D = 5.5 A,	-	15	30	
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g = 9.1 Ω	-	55	110	ns
Fall time	t _f			-	18	36	
Gate input resistance	Rg	f = 1	MHz, open drain	0.4	0.9	1.8	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the	ibol	-	-	12	
Pulsed diode forward current	I _{SM}		integral reverse p - n junction diode		-	32	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 5.5 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	345	690	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}} = 5.5 \text{A},$	-	4.2	8.4	μC
Reverse recovery current	I _{BBM}		100 A/µs, V _R = 25 V	-	21	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

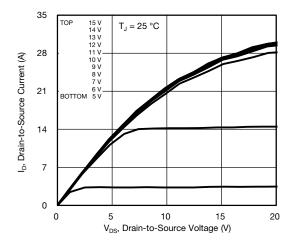
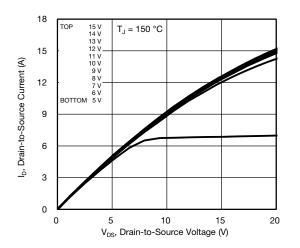
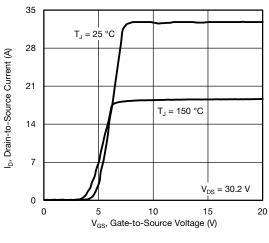


Fig. 1 - Typical Output Characteristics









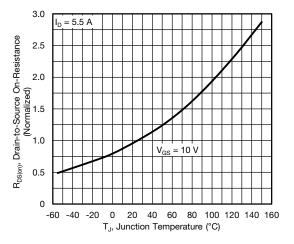


Fig. 4 - Normalized On-Resistance vs. Temperature

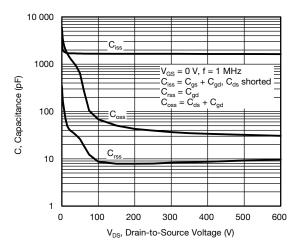


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

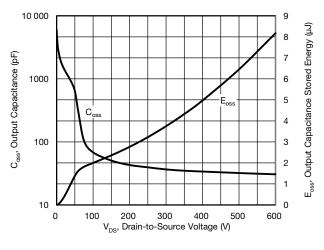


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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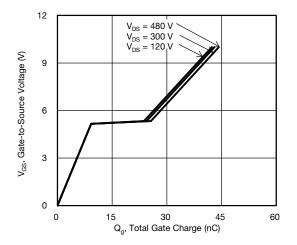


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

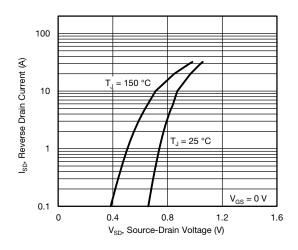


Fig. 8 - Typical Source-Drain Diode Forward Voltage

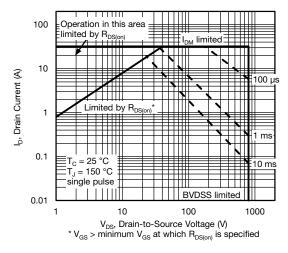


Fig. 9 - Maximum Safe Operating Area

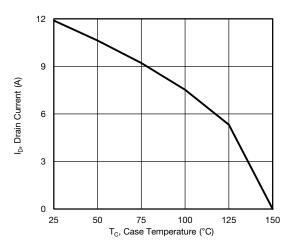


Fig. 10 - Maximum Drain Current vs. Case Temperature

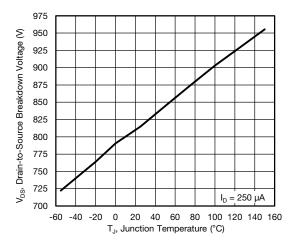
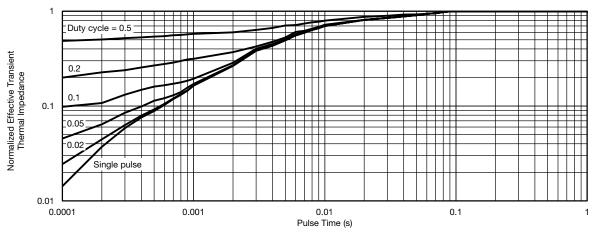


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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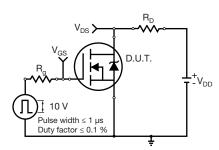


Fig. 13 - Switching Time Test Circuit

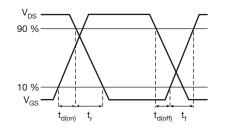


Fig. 14 - Switching Time Waveforms

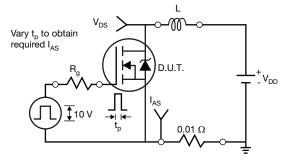
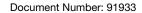


Fig. 15 - Unclamped Inductive Test Circuit

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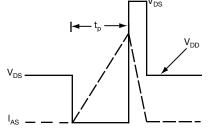


Fig. 16 - Unclamped Inductive Waveforms

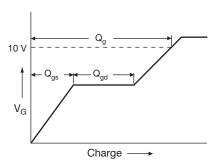
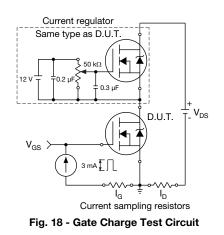


Fig. 17 - Basic Gate Charge Waveform





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Peak Diode Recovery dv/dt Test Circuit

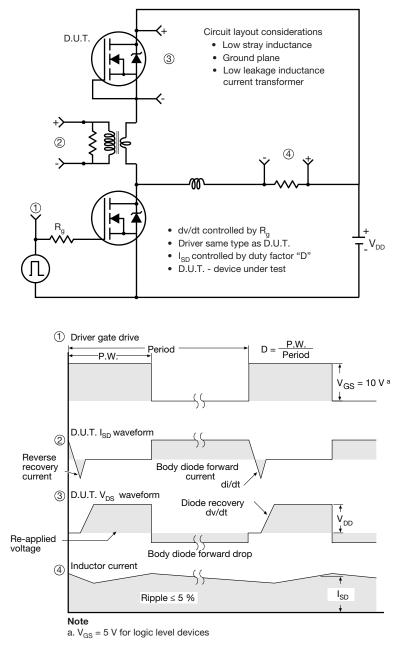


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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